



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Group Art Unit: 2814
Examiner: Phat X. Cao

In re PATENT APPLICATION of:

Applicant(s): Nobuhisa KUMAMOTO et al.

Serial No.: 10/767,439

Filing date: January 30, 2004

For: PROCESS OF PRODUCING
SEMICONDUCTOR CHIP WITH
SURFACE INTERCONNECTION
AT BUMP (as amended)

Atty. ref.: AI 318 D1

**PETITION FOR
EXTENSION OF TIME**

March 19, 2007

Director of Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Please extend the period for responding to the Office Action of October 18, 2006 by two months, and thus until March 18, 2007(a Sunday, and consequently on Monday, March 19, 2007).

A remittance that includes the \$450 extension fee is being submitted concurrently. Should this remittance be accidentally missing or insufficient, though, any fees that may be needed can be charged to our Deposit Account number 18-0002.

Respectfully submitted,

Allen Wood

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450.00 OP

AW/ng